



# **Tamper Detection/Response for MachXO3D Devices**

## **Technical Note**

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## Contents

Acronyms in This Document .....	5
1. Introduction .....	6
2. Overview of Tamper Detection/Response .....	7
2.1. Types of Tamper Detection .....	7
2.1.1. Password Tampering .....	7
2.1.2. Memory (Flash/SRAM) Tampering .....	7
2.1.3. Manufacturing Access Tampering .....	8
2.2. Source of Tamper .....	8
2.3. Tamper Response .....	8
3. Port Description of Tamper Detection / Response .....	9
3.1. Detailed Port Description .....	10
3.1.1. tamper_detect_clk .....	10
3.1.2. tamper_detect_in .....	10
3.1.3. tamper_src_lock .....	10
3.1.4. tamper_detect .....	10
3.1.5. tamper_type[1:0] .....	10
3.1.6. tamper_src[1:0] .....	11
4. Enabling Tamper Detection Using Diamond Software .....	12
4.1. Tamper Detection User Configurable Options .....	13
4.1.1. Tamper Type Register .....	13
4.1.2. Tamper Source Register .....	13
4.1.3. Port Lock .....	13
5. Tamper Detection/Response Timing .....	14
5.1. Tamper Clock Timing Specification .....	14
5.2. Tamper Detection .....	14
5.2.1. Enable Tamper Detection .....	14
5.2.2. Threat Detection .....	14
5.2.3. Reset Tamper Detection .....	14
5.3. Tamper Response .....	15
5.3.1. Enable Port Lock .....	15
5.3.2. Disable Port Lock .....	15
Technical Support Assistance .....	16
Revision History .....	17

## Figures

Figure 2.1. Tamper Detection Architecture in MachXO3D Device Tamper Detection .....	7
Figure 2.2. Tamper Response Block Diagram .....	8
Figure 3.1. Tamper Detection Ports.....	9
Figure 4.1. EFB Module with Tamper Detection/Response Enabled .....	12
Figure 4.2. Tamper Configuration Options in EFB Module .....	13
Figure 5.1. Tamper Detection Timing Diagram .....	14
Figure 5.2. Tamper Response (Port lock) Timing Diagram .....	15

## Tables

Table 3.1. Ports for Tamper Detection/Response .....	9
Table 5.1. Tamper Clock Timing Specification .....	14

## Acronyms in This Document

A list of acronyms used in this document.

Acronym	Definition
EFB	Embedded Function Block
I <sup>2</sup> C	Inter-Integrated Circuit
JTAG	Joint Test Action Group
SPI	Serial Peripheral Interface
SRAM	Static Random Access Memory
SSPI	Slave Serial Peripheral Interface
SI2C	Slave Inter-Integrated Circuit
WB	WISHBONE

## 1. Introduction

The MachXO3D™ device family is the next generation of Lattice Semiconductor low density PLDs including enhanced security features and on-chip dual boot flash. One of the new and unique features of the MachXO3D device is the Tamper Detection and Response. This Tamper Detection feature gives the MachXO3D device the capability to monitor the configuration ports as well as memory access (Flash and SRAM). Using this feature, the MachXO3D prevents any illegal device access.

Once Tamper Detection is enabled, the MachXO3D monitors and informs you of any malicious activity on the configuration ports of the device. With this feature, you are able to detect a variety of threats from the configuration ports. These threats include any commands/instructions that are used to access a locked MachXO3D device. The MachXO3D device also classifies these attacks based on type and source.

## 2. Overview of Tamper Detection/Response

At a very high level, the Tamper Detection/Response feature works closely with user logic to indicate if there is any illegal device access. This illegal device access includes access using external configuration ports or access to locked flash sectors and SRAM. As shown in Figure 2.1, the Tamper Detection feature is enabled by configuring the EFB module to enable Tamper Detection/Response. Once enabled, this tamper is continuously monitoring the activity on external configuration ports as well as memory access (Flash sector and SRAM). The EFB module is instantiated using the IP Express tool in Diamond software tool, refer to [Enabling Tamper Detection Using Diamond Software](#) section.

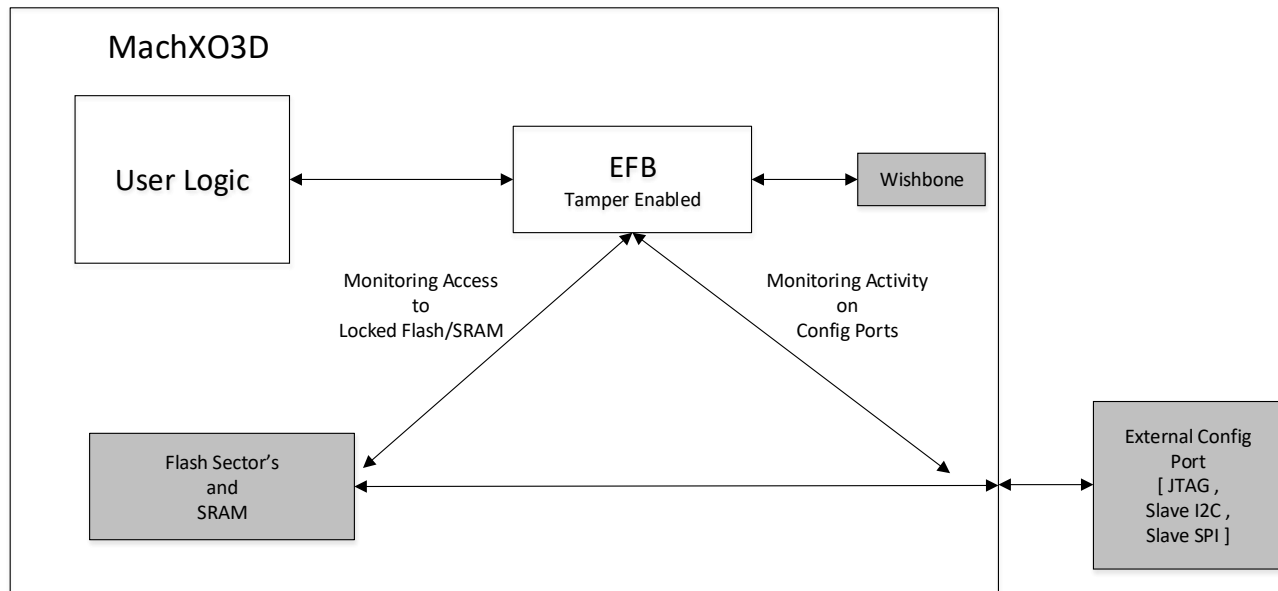


Figure 2.1. Tamper Detection Architecture in MachXO3D Device Tamper Detection

This Tamper Detection feature in MachXO3D devices not only identifies the tamper but it also classifies the tamper based on the type of attack as well as the source of attack. This classification gives you the capability to take distinct action towards the attack and protect any further device access.

### 2.1. Types of Tamper Detection

The MachXO3D device not only detects the attack but also classifies the type of tamper based on the type of command/instructions used to attack the device. These attacks are classified in three categories. You have the capability to enable/disable the type of attack using the Tamper Detection configuration options in the IP Express tool.

#### 2.1.1. Password Tampering

Password Tampering refers to accessing a password protected MachXO3D device. In the Tamper Detection/Response user interface configuration, this tamper type is called Password Protection.

When the Password Protection feature is on, it informs you if an attacker is trying to access the device using an incorrect password or without entering the password if the device is password protected.

#### 2.1.2. Memory (Flash/SRAM) Tampering

Memory Tampering refers to accessing locked Flash sector or locked SRAM. In the Tamper Detection/Response user interface configuration, this tamper type is called Locked Flash/SRAM.

This type of tamper detects if you are accessing a locked Flash sector or locked SRAM. This tamper type informs you if an attacker is trying to issue any commands/instructions that are being used to access a locked MachXO3D device.

### 2.1.3. Manufacturing Access Tampering

This type of tamper detects if you are trying to issue manufacturing mode commands. This tamper type is useful to identify tampering outside the usual norms. With this tamper type, some device features, that are used for Lattice internal purposes, are flagged if they are being used by the user.

## 2.2. Source of Tamper

The device also has the capability to monitor and report which configuration interface is the source of tamper. The MachXO3D monitors the following configuration sources:

- Wishbone
- Slave SPI
- Slave I<sup>2</sup>C
- JTAG

## 2.3. Tamper Response

In response to a Tamper event, you may choose to lock the configuration interfaces via user logic to prevent further tampering.

The Port lock feature allows you to lock configuration ports. This port lock feature is useful after a tamper is detected on any configuration port. Refer to [Tamper Detection User Configurable Options](#) and the [Tamper Detection/Response Timing](#) section for more details on Tamper configuration and response.

Once the *tamper\_src\_lock* signal is asserted, all monitored configuration ports are locked. Appropriate care should be exercised in determining which configuration ports to monitor, and when to lock those same MachXO3D configuration ports.

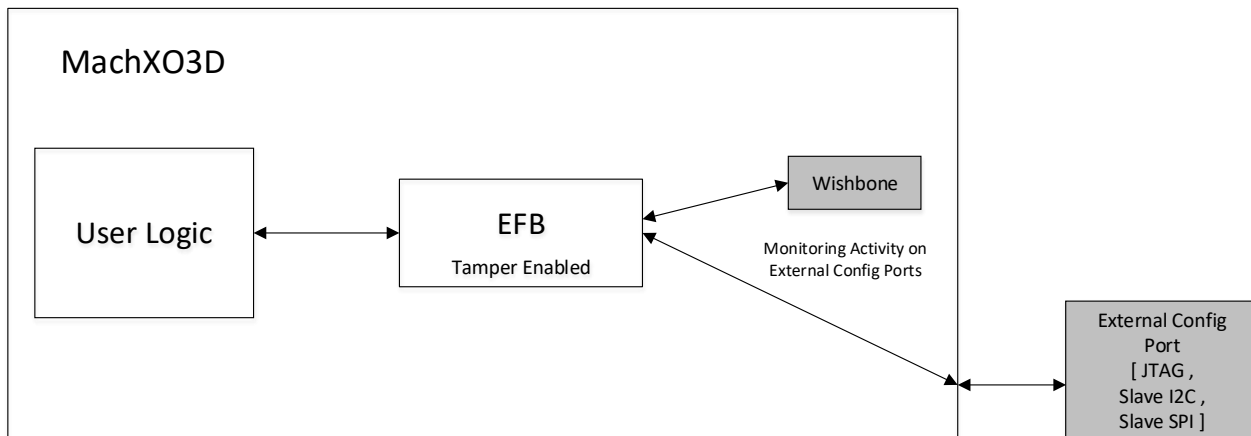


Figure 2.2. Tamper Response Block Diagram



### 3. Port Description of Tamper Detection / Response

Figure 3.1 shows the interface between User logic and the Tamper section of the EFB module.

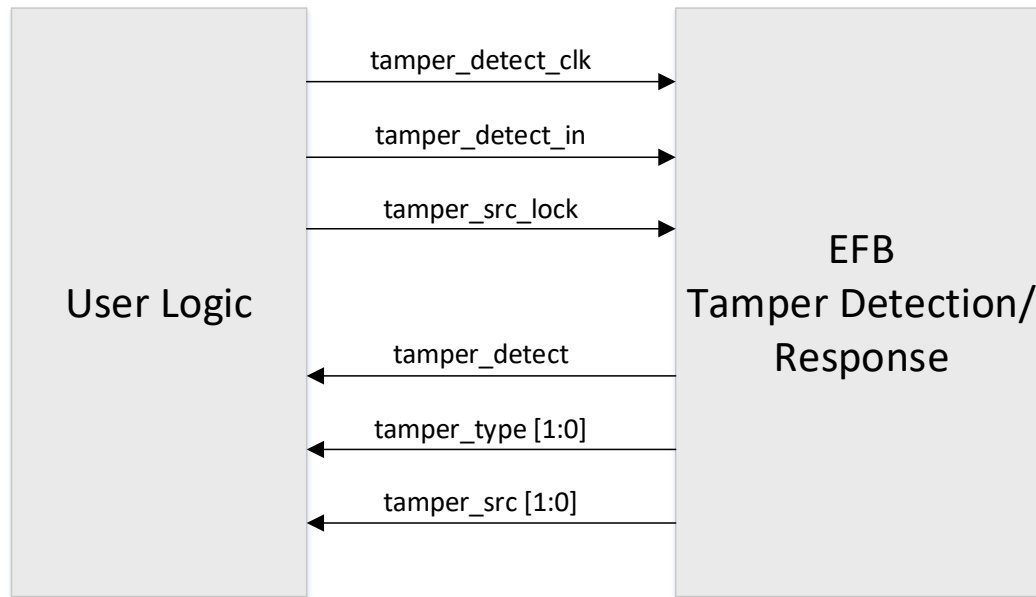


Figure 3.1. Tamper Detection Ports

Table 3.1. Ports for Tamper Detection/Response

Port Name	Input/Output	Default	Description
tamper_detect_clk	Input	—	Clock input to the Tamper Detection module.
tamper_detect_in	Input	—	Used to enable/disable Tamper Detection: 1 – Tamper Detection Enabled 0 – Tamper Detection Disabled
tamper_src_lock	Input	—	Used to lock all monitored configuration ports: 1 – Configuration Ports Locked 0 – Configuration Ports Unlocked
tamper_detect	Output	0	Used to indicate if tamper is detected on a monitored port: 1 – Tamper Detected 0 – Tamper Not Detected
tamper_type[1:0]	Output	00	Used to report the tamper type: 00 – Reserved 01 – Password Protection 10 – Locked Flash / SRAM 11 – Manufacture mode
tamper_src[1:0]	Output	00	Used to report the tamper source: 00 – Wishbone (WB) 01 – Slave SPI (SSPI) 10 – Slave I <sup>2</sup> C (SI <sup>2</sup> C) 11 – JTAG

## 3.1. Detailed Port Description

This section describes in detail the port description of the Tamper Detection/Response module.

### 3.1.1. tamper\_detect\_clk

This signal is used to provide the clock to the Tamper Detection module. The clock signal should be uninterrupted for this module to function at all times. All output signals are in this clock domain. Refer [Tamper Detection/Response Timing](#) section for the clock frequency requirements and detailed timing diagrams.

### 3.1.2. tamper\_detect\_in

This signal is used to enable/disable the Tamper Detection module. The user logic drives this signal high to enable the Tamper Detection module inside EFB. Once enabled, the Tamper Detection is active and continuously monitoring the selected configuration ports and memory accesses:

- 1 – Tamper Detection Enabled
- 0 – Tamper Detection Disabled

Clearing (set to 0) the *tamper\_detect\_in* signal resets the *tamper\_detect* output signal by pulling it low.

### 3.1.3. tamper\_src\_lock

This signal is used to lock configuration ports. Once tamper is detected, the user logic can choose to lock the configuration ports to prevent further device attack. To lock the pre-selected configuration ports, the user logic drives this signal high. Once the port is locked, any UFM, internal fabric, and device access which includes reading, writing, and erasing is blocked.

- 1 – Configuration ports locked
- 0 – Configuration ports unlocked

The configuration option *Port Lock* must be selected in IPexpress to enable the operation of *tamper\_src\_lock*. See [Port Lock](#) section for more details.

### 3.1.4. tamper\_detect

This signal is used to indicate the detection of tamper. Once tamper is detected, the EFB module sends this signal to the user logic indicating Tamper Detection. Once the *tamper\_detect* signal goes high, use the *tamper\_detect\_in* signal to reset the Tamper Detection logic. Refer to [Tamper Clock Timing Specification](#) section for the detailed timing diagram.

- 1 – Tamper Detected
- 0 – Tamper Not Detected

### 3.1.5. tamper\_type[1:0]

This signal is used to report the type of tamper once tamper is detected. This signal gives you more information about the detect tamper as the EFB module classifies this tamper in the categories below.


Bits	Tamper Type
00	Reserved
01	Password Protection
10	Locked Flash/SRAM
11	Manufacture mode

### 3.1.6. tamper\_src[1:0]

This signal is used to report the source of tamper once tamper is detected. This signal gives you information about the configuration interface that is used for the attack.

Bits	Tamper Source
00	Wishbone (WB)
01	Slave SPI (SSPI)
10	Slave I <sup>2</sup> C (SI <sup>2</sup> C)
11	JTAG

## 4. Enabling Tamper Detection Using Diamond Software

To enable the Tamper Detection feature in MachXO3D device, you have to instantiate the EFB primitive using IP Express 

To enable this feature in the EFB primitive, select the Tamper Detection/Response option in IP Express as shown in Figure 4.1.

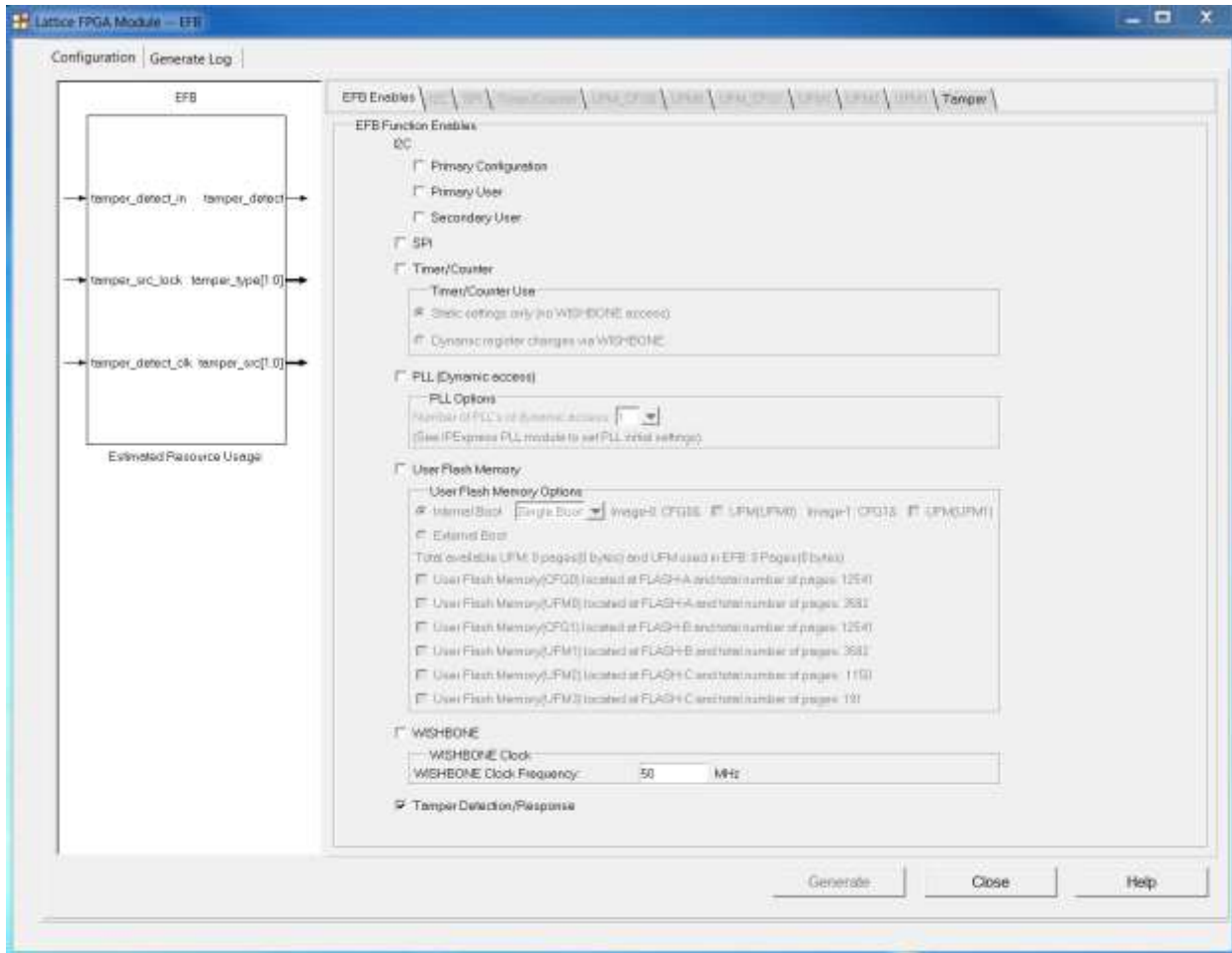


Figure 4.1. EFB Module with Tamper Detection/Response Enabled

## 4.1. Tamper Detection User Configurable Options

The Tamper Detection user interface gives you the option to select the type and source of tamper that needs monitoring. With this feature, you have flexibility of enabling/disabling particular configuration ports based on their active usage.

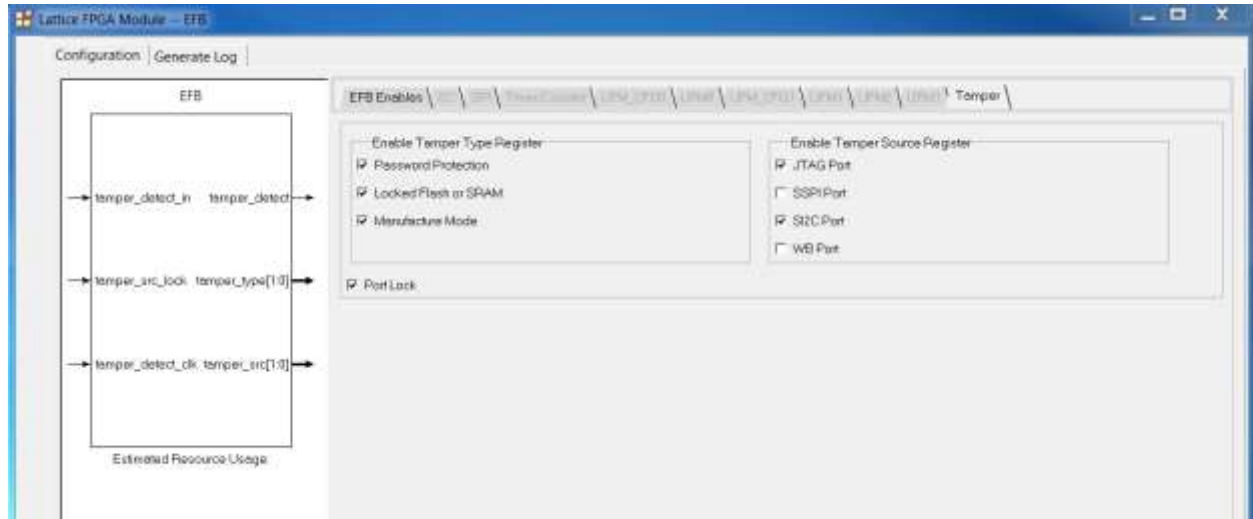


Figure 4.2. Tamper Configuration Options in EFB Module

### 4.1.1. Tamper Type Register

The Tamper Type Register is used to specify which types of Tamper Detection are active. There are three different tamper types:

- Password Tampering – Password Protection
- Memory Tampering – Locked Flash or SRAM
- Manufacturing Access Tampering – Manufacture Mode

For more details on the tamper types, refer to the [Types of Tamper](#) section.

### 4.1.2. Tamper Source Register

The Tamper Source Register is used to specify which ports are monitored. There are four tamper sources based on the ports used to interface with the MachXO3D device:

- JTAG port – Monitor JTAG configuration port
- SSPI Port – Monitor the Slave SPI configuration port
- SI2C Port – Monitor Slave I2C configuration port
- WB Port – Monitor Wishbone configuration port

In [Figure 4.2](#), for example, monitoring for malicious activity on JTAG and SI2C Ports is enabled.

### 4.1.3. Port Lock

Checking *Port Lock* allows the *tamper\_src\_lock* input to lock the Enabled Tamper Sources when asserted. Un-checking *Port Lock* disables the *tamper\_src\_lock* input.

## 5. Tamper Detection/Response Timing

### 5.1. Tamper Clock Timing Specification

Table 5.1. Tamper Clock Timing Specification

Parameter	Min	Max	Units
tamper_detect_clk	0.00001	133*	MHz

\*Note: When running the clock at high speed, you have to comply with the delay requirements of the Tamper Detection logic. Refer to Figure 5.2 for the detailed timing diagram.

### 5.2. Tamper Detection

The Tamper Detection logic is running on the *tamper\_detect\_clk* clock domain.

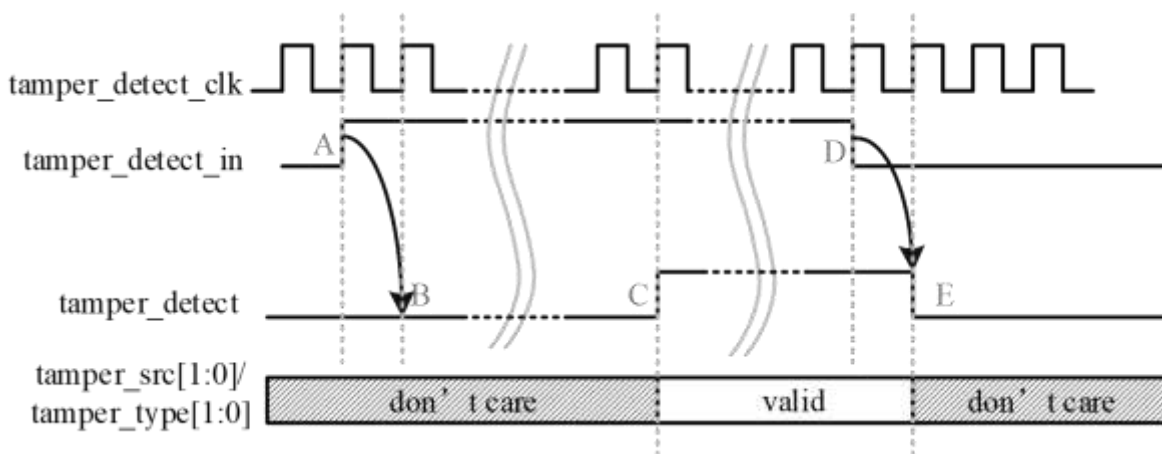


Figure 5.1. Tamper Detection Timing Diagram

#### 5.2.1. Enable Tamper Detection

To enable the Tamper Detection, you must set the *tamper\_detect\_in* signal high (A).

The next rising edge of the *tamper\_detect\_clk* signal enables the detection logic (B) which enables the Tamper Detection.

#### 5.2.2. Threat Detection

Once threat is detected, the *tamper\_detect* signal goes high (C).

Tamper Detection logic outputs the below information about the detected treat:

- *tamper\_src* describes the source of the tamper
- *tamper\_type* describes the tamper type

#### 5.2.3. Reset Tamper Detection

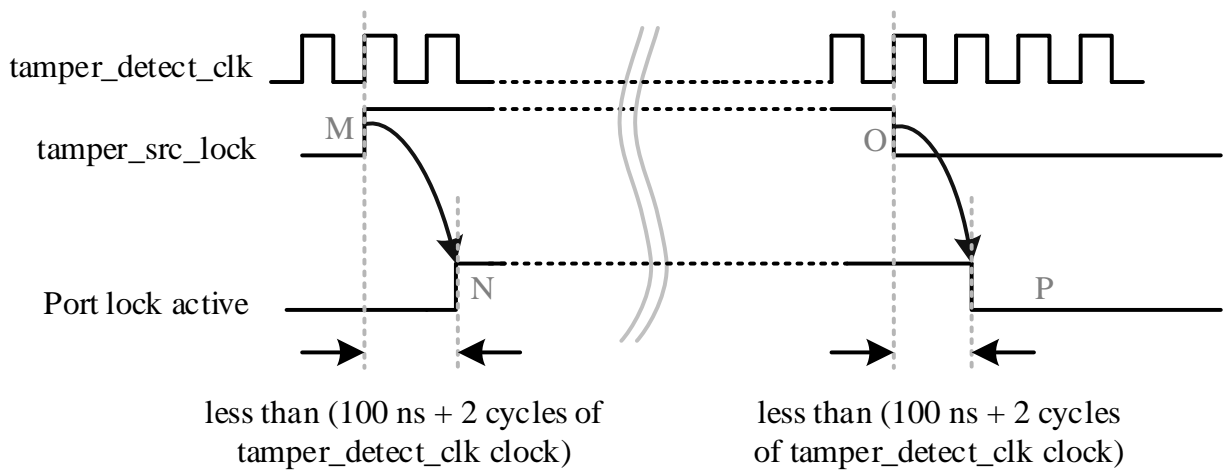
To reset the Tamper Detection logic, pull the *tamper\_detect\_in* signal low (D).

On the next rising edge of the clock, the *tamper\_detect* goes low and resets the Tamper Detection logic inside EFB module (E).

Once the Tamper Detection module is reset, Tamper Detection is re-enabled by asserting *tamper\_detect\_in* signal high after a minimum of three *tamper\_detect\_clk* cycles.

### 5.3. Tamper Response

The tamper response logic is also running on the *tamper\_detect\_clk* clock domain.



**Figure 5.2. Tamper Response (Port lock) Timing Diagram**

#### 5.3.1. Enable Port Lock

Once the threat is detected, you can choose to lock the pre-selected configuration ports to prevent any further attack on the device.

To enable the configuration port lock, enable the *tamper\_src\_lock* signal (M).

Once enabled, the configuration ports are locked after a certain delay (N) as shown in [Figure 5.2](#).

#### 5.3.2. Disable Port Lock

To unlock (re-enable) the configuration ports, drive the *tamper\_src\_lock* signal low (O).

Once this signal is driven low, the configuration ports are unlocked after a certain time delay (P).

## Technical Support Assistance

Submit a technical support case through [www.latticesemi.com/techsupport](http://www.latticesemi.com/techsupport).



## Revision History

### Revision 1.0, August 2021

Section	Change Summary
All	Production release.



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